

STRUCTURE

Silicon Monolithic Integrated Circuit

PRODUCT SERIES

BTL driver for CD/CD-ROM

TYPE

BA 5 9 8 3 FP

PACKAGE OUTLINES

Figure 1 (Plastic Mold)

POWER DISSIPATION

Figure 2

BLOCK DIAGRAM

Figure 3

APPLICATION

Figure 4

TEST CIRCUIT

Figure 5

FUNCTIONS

- · 4ch BTL Driver.
- · Small surface mounting power package (HSOP 28).
- Wide dynamic range. (4V(typ.) at PreVcc=12V,PowVcc=5V,RL=8Ω)
- · Thermal shut down circuit built in.
- Separating Vcc into Pre and Power (Power divides into CH1/2 and CH3/4), can make better power efficiency, by low supply voltage drive.
- · Mute operated individually CH4 and CH1/2/3.
- · All channels mute is stand by mode.
- · Suitable for low operation voltage DSP by wide D-range pre opamp.

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Limits	Unit
Supply voltage	PreVcc,PowVcc	13.5	V
Power dissipation	Pd	1.7 #1	W
Max output current	Ionax	1 # 2	Α
Operating temperature	Topr	-35 ~ 85	°C
Storage temperature	Tstg	-55 ~ 150	°C

 ^{#1} On less than 3% (percentage occupied by copper foi), 70x 70mm², t=1.6mm, glass epoxy mounting. Reduce power by 13.6mW for each degree above 25°C.
 #2 The output current must not exceed the maximum Pd and ASO.

GUARANTEED OPERATING RANGES

Parameter	Symbol	Limits	Unit
Vcc for pre block	PreVcc	4.5~ 13.2	V
Vcc for power block	PowVcc	4.5~ PreVcc	V



ELECTRICAL CHARACTERISTICS

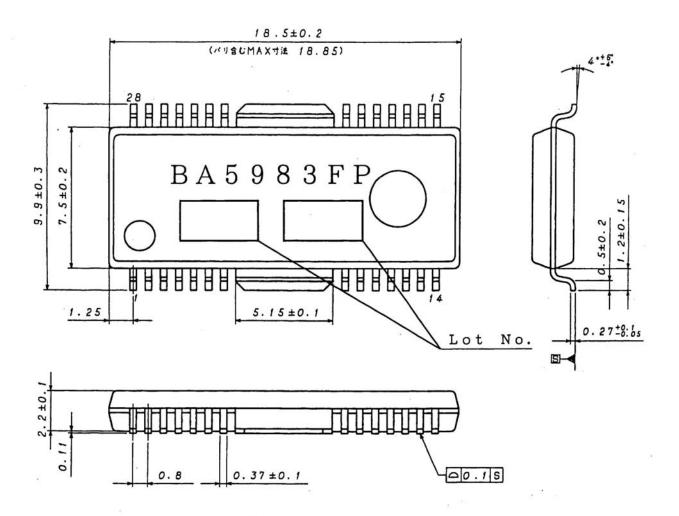
(Unless otherwise noted, Ta=25 °C, PreVcc=8V,PowVcc1=5V,PowVcc2=8V,Veias =1.65V,RL=8 Ω)

Parameter	Symbol	Min.	Тур.	Max.	UNIT	Conditions	Test circuit
Quiescent current	IQ	_	20	32	m A	R L =00	Fig.5
CH1-3 Standby Current	IQ _{sT1}	_	6.2	13	mA	R L =00	Fig.5
CH4 Standby Current	IQ ₆₇₂	_	16	26	m A	R L =00	Fig.5
All Channel Standby Current	IQ ₈₇₃	_	_	1	m A	R _L =∞	Fig.5
<driver block=""></driver>							
Output offset voltage	Voor	-70	_	70	m V		Fig.5
Maximum output voltage 1	Vomi	3.6	4.0	_	V	CH1,2 VIN=Vыз ± 1.65V	Fig.5
Maximum output voltage 2	V _{OM2}	5.4	6.0	-	V	CH3,4 VIN=V _{BIAS} ± 1.65V	Fig.5
Closed loop voltage gain 1	Gvcı	10	12	14	d B	CH1,2 VIN=VBIAS ± 0.5V	Fig.5
Closed loop voltage gain 2	Gvc2	16	18	20	d B	CH3,4 VIN=VBIAS ± 0.5V	Fig.5
Slew Rate	SRDRV	_	2	_	V	Input pulse 100kHz,2Vp-p	Fig.5
Standby on voltage	VSTon	_	-	0.5	V		Fig.5
Standby off voltage	VSToff	2.0	_	-	V		Fig.5
Bias drop mute on voltage	VBMbn	_	-	0.7	V		Fig.5
Bias drop mute off voltage	VBMoff	1.3	_	1	V		Fig.5
<pre amplifier="" operational=""></pre>							
Common mode input range	Vicm	0	-	6.8	V		Fig.5
Input offset voltage	Vofor	-6	0	6	mV		Fig.5
Input bias current	Івор	-	_	300	n A		Fig.5
High level output voltage	Vohop	7	7.8	1	V	V _{BIAS} =4V	Fig.5
Low level output voltage	V6LOP	_	-	0.3	V	Valas =4V	Fig.5
Output sink current	Ist	1	_	_	m A	output to PreVcc by 501, Valas = 4V	Fig.5
Output source current	I so	300	500	_	μΑ	output to GND by 500, Value =4V	Fig.5
Slew rate	SROP	-	2	-	V/μ s	Input pulse 100kHz,2Vp-p	Fig.5

O This product is not designed for protection against radioactive rays.



PACKAGE OUTLINES (mm)



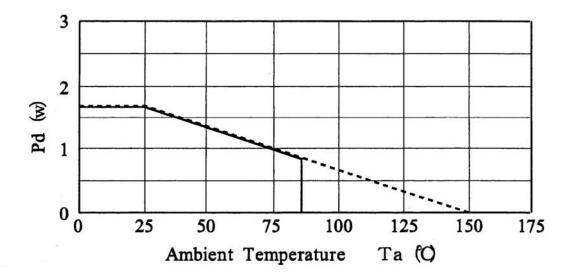
(UNITimm)

図番: EX140-5001-1

Figure 1



POWER DISSIPATION / Electrical characteristic curves



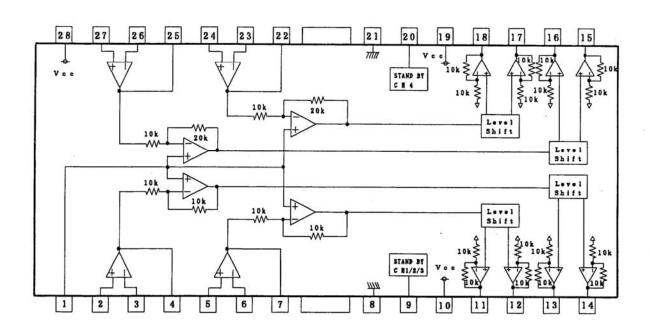
Pd: power dissipation

 \star On less than 3% (percentage occupied by copper foi), 70 \times 70mm² ,t=1.6mm glass epoxy mounting.

Figure 2



BLOCK DIAGRAM



resistor unit : Ω

Figure 3

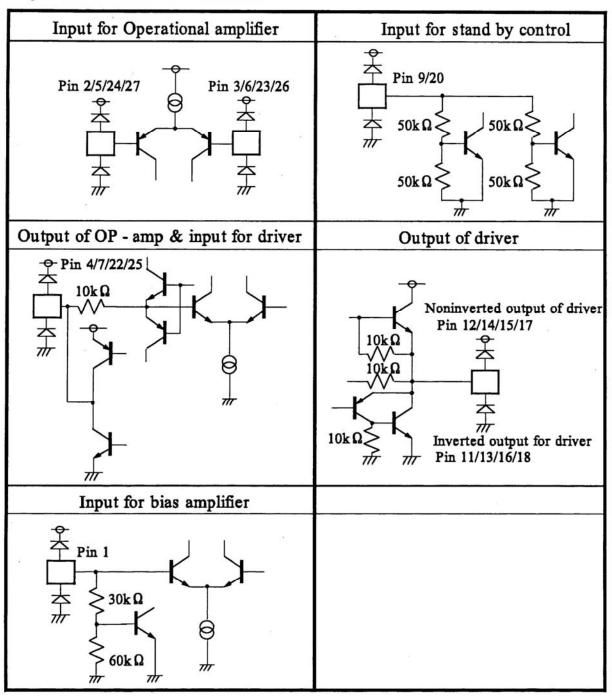
Pin description

	I III desci	.p.i.o.i			
NO	Symbol	Function	NO	Symbol	Function
1	BIAS IN	Input for Bias-amplifier	15	VO4(+)	Non inverted output of CH4
2	OPIN1(+)	Non inverting input for CH1 OP-AMP	16	VO4(-)	Inverted output of CH4
3	OPIN1(-)	Inverting input for CH1 OP-AMP	17	VO3(+)	Non inverted output of CH3
4	OPOUT1	Output for CH1 OP-AMP	18	VO3(-)	Inverted output of CH3
5	OPIN2(+)	Non inverting input for CH2 OP-AMP	19	PowVcc2	Vcc for CH3/4 power block
6	OPIN2(-)	Inverting input for CH2 OP-AMP	20	STBY2	Input for CH4 stand by control
7	OPOUT2	output for CH2 OP-AMP	21	GND	Substrate ground
8	GND	Substrate ground	22	OPOUT3	Output for CH3 OP-AMP
9	STBY1	Input for CH1/2/3 stand by control	23	OPIN3-)	Inverting input for CH3 OP-AMP
10	PowVcc1	Vcc for CH1/2 power block	24	OPIN3+)	Non inverting input for CH3 OP-AMP
11	VO2(-)	Inverted output of CH2	25	OPOUT4	Output for CH4 OP-AMP
12	VO2(+) -	Non inverted output of CH2	26	OPIN4(-)	Inverting input for CH4 OP-AMP
13	VO1(-)	Inverted output of CH1	27	OPIN4(+)	Non inverting input for CH4 OP-AMP
14	VO1(+)	Non inverted output of CH1	28	Pre Vcc	Vcc for pre block

notes) Symbol of + and - (output of drivers) means polarity to input pin. (For example if voltage of pin4 high,pin14 is high)



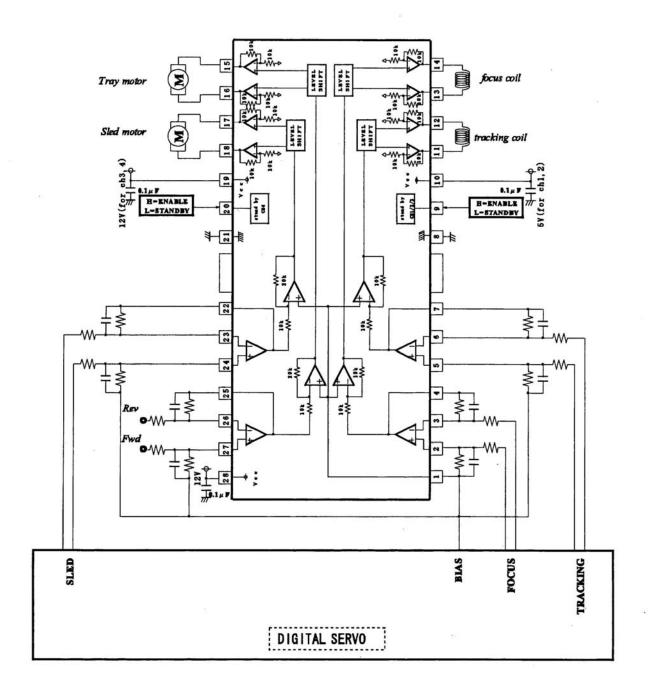
EQUIVALENT CIRCUIT OF TERMINALS



resistor unit : Ω



Application circuit

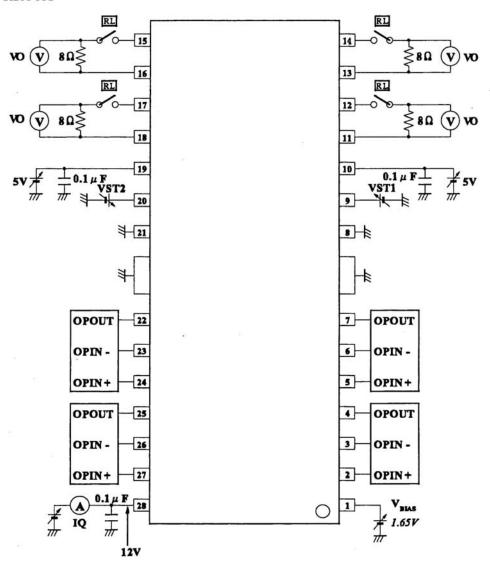


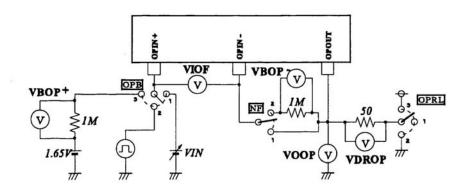
resistor unit : Ω

Figure 4



TEST CIRCUIT





resistor unit : Ω

Figure 5



Table of measuring circuit switches

1) Quiescent current or standby (VIN= V_{BlAS} =1.65V, OPB \rightarrow 1, RL \rightarrow OFF, NF \rightarrow 1, OPRL \rightarrow 1)

0 11	Inp	ut	0.4	
Symbol	VST1	VST2	Conditions	Measuring point
IQ	5V	5V		IQ
IQST1	0V	5V		IQ
IQST2	5V	0V		IQ
IQST3	0 V	0 V		IQ

2) Driver block (OPB \rightarrow 1,NF \rightarrow 1,OPRL \rightarrow 1, RL \rightarrow ON)

Symbol	SW		Inp	ut	M.L.		
	OPB	VIN	VST1	VST2	VBIAS	Condition	Measuring point
V001	1	1.65V	2.0V	2.0V	1.65V		VO (CH1,2)
VOO2	1	1.65V	2.0V	2.0V	1.65V		VO (CH3,4)
VOM1	1	± 1.65V	2.0V	2.0V	1.65V	VIN=0V or 3.3V	VO (CH1,2)
VOM2	1	± 1.65V	2.0V	2.0V	1.65V	VIN=0V or 3.3V	VO (CH3,4)
GVC1	1	± 0.5V	2.0V	2.0V	1.65V	VIN=1.15V or 2.15V	VO (CH1,2)
GVC2	1	± 0.5V	2.0V	2.0V	1.65V	VIN=1.15V or 2.15V	VO (CH3,4)
VSTON	1	3.0V	0.5V	0.5V	1.65V	Check output of driver is muted.	vo
VSTOFF	1	3.0V	2.0V	2.0V	1.65V	Check output of driver is active.	vo
VBMON	1	3.0V	0.5V	0.5V	0.5V	Check output of driver is muted.	vo
/BMOFF	1	3.0V	2.0V	2.0V	1.3V	Check output of driver is active.	vo
SRDRV	2	± 1V	2.0V	2.0V	1.65V	Input pulse 100kHz, *2V _P -	vo

3) Pre operational amplifier (VST1=VST2=2V,RL→ OFF)

C		Switch		Inp	ut		
Symbol	OPB	NF	OPRL	VIN	VBIAS	Conditions	Measuring point
VOFOP	1	1	1	1.65V	1.65V		VIOF
VBOP	3	2	1	1.65V	1.65V		VBOP/1M
VOHOP	1	1	1	12V	6V	VBIAS=VCC/2	VOOP
VOLOP	1	1	1	0V	6V	Veias=VCC/2	VOOP
ISI	1	1	3	6V	6V	VBIAS=VCC/2	VDROP/50 ₽
ISO	1	1	2	6V	6V	VBIAS=VCC/2	VDROP/50 ₽
SROP	2	1	1	± 1.0V*	1.65V	Input pulse 100kHz, *2V _{PP}	VOOP



Notes on use

- 1. Thermal shut down circuit is built in. In case IC chip temperature rises to 175°C(typ), thermal shut down circuit operates and muted the output current. Next time IC chip temperature falls below 150°C(typ), the driver blocks start.
- 2. Bias pin (pin1) should be pulled up more than 1.3V. In case bias pin voltage is under 0.7V(typ), output current is muted.
- 3. In case supply voltage falls below 3.8V(typ.), output current is muted. Next time supply voltage rises to 4.0V (typ.), the driver blocks start.
- 4. Mute operation is caused by thermal shut down, decrease of bias pin voltage or decrease of supply voltage, when mute is done, output voltage becomes internal reference voltage about PowVcc/2.
- 5. In case of one of the standby terminals turn into or open, correspondence channel circuit include opamps is muted.
- 6. Both of the standby terminals low or open, all circuits shutdown (sleep mode) and all output pins become high impedance.
 In addition to threshold is 1.4V(typ.).
- 7. Supply voltage of PreVcc should be equal to or higher than PowVcc.
- 8. Take care the external resister value of OPamp. OPamp source current supplies to internal resister ($10K\Omega$) as well as external resister.
- 9. Insert the by pass capacitor between Vcc pin and GND pin of IC as near as possible (approximately 0.1 μ).
- 10. Keep the GND pin voltage the lowest of all pins.
- 1 1. Heat dissipation fins are attached to the GND on the inside of the package. Make sure to connect these to the external GND.

Notes

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